



# SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	24.000000 MHz
HOLDER TYPE	TYPE FY 5.0x3.2 SEAM SEALED CRYSTAL
SPEC. NO. ( P/N )	FY2400054
CUSTOMER P/N	
ISSUE DATE	September 29, 2017
VERSION	D

APPROVED	PREPARED	QA
Brenda	Vikbi Lu	Dong Jang

### **Diodes Incorporation**

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TEL: 886-3-451-8888 FAX: 886-3-461-3865 http://www.diodes.com \*Pb-free

\*RoHS Compliant

\*HF-Halogen Free

\*REACH Compliant

E0-R-4-014 Rev. F

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# **VERSION HISTORY**

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
А	Jun.15,2010			Initial Release	
В	Aug.12,2010			New Logo	
С	Mar.1,2011			Updated Suggested IR Reflow Profile & Format	
D	Sep.29,2017			Updated logo	

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#### **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	24.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	18	pF	
Calibration Tolerance	FL	±30	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +85	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±30	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	50	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25°C		±5	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	МΩ	Min

\* This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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#### **RELIABILITY SPECIFICATIONS**

#### **MECHANICAL AND ENVIRONMENTAL RATINGS:**

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY: (RoHS version): J-STD-002

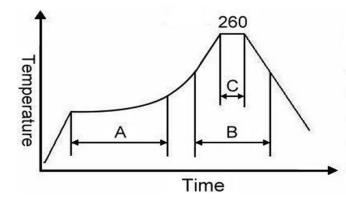
f) VIBRATION: JESD22-B103

g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D

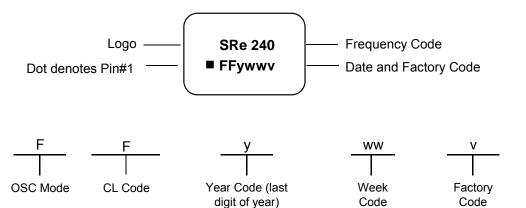


Note	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
C	Peak	260°C	10 Sec

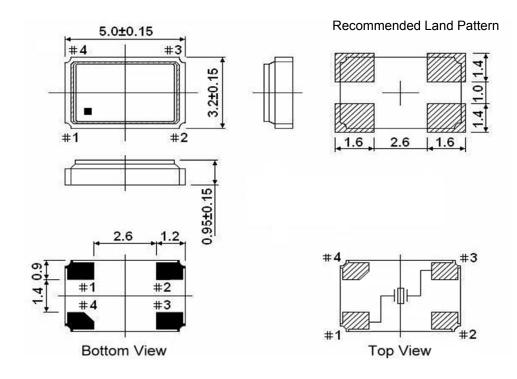
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#### **MARKING**



### **MECHANICAL DRAWINGS** (Scale: None. Dimensions are in mm.)



\*\* Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

#### Notes

- Package drawings are for reference only, and the appearances of objects may vary.
  Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.

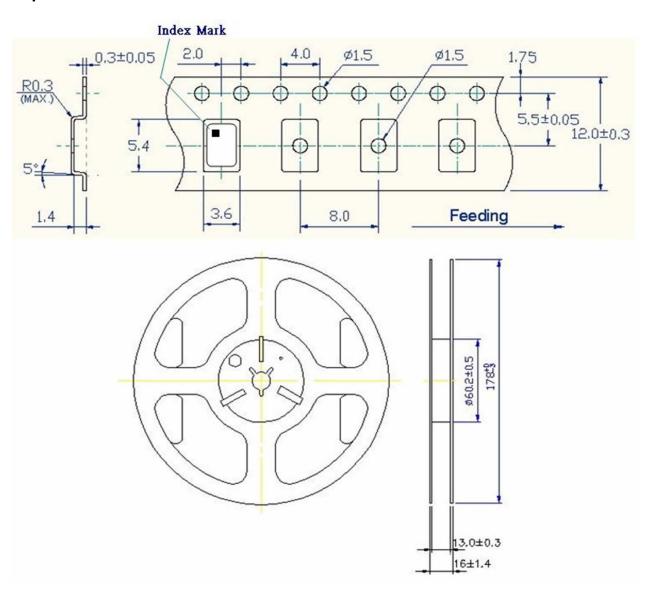
DEDES

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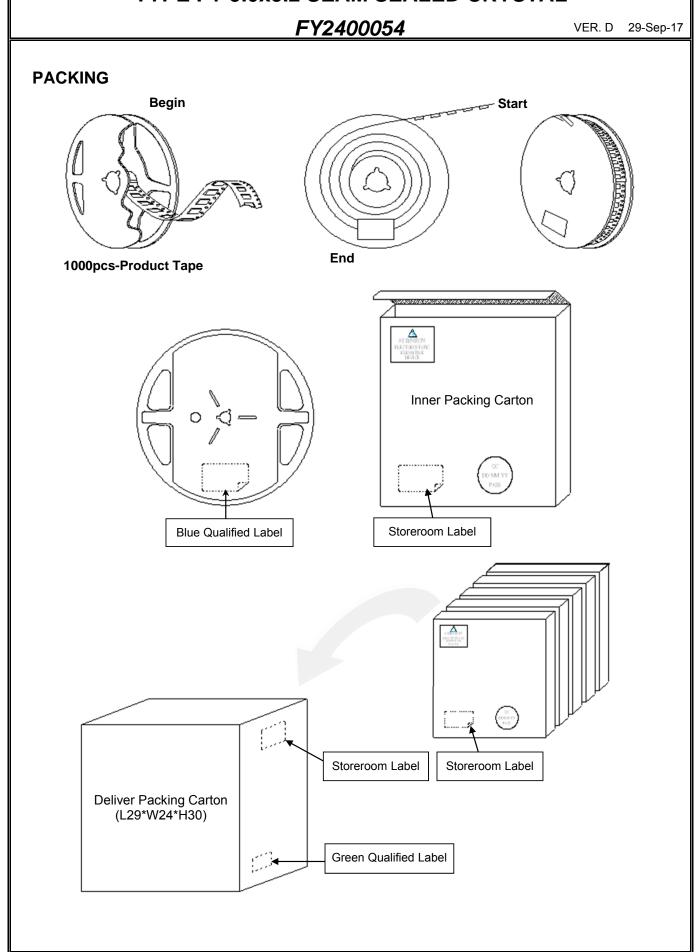
### Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.



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